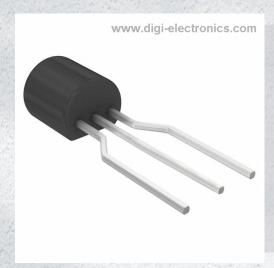


BS107ARL1 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number BS107ARL1-DG

Manufacturer onsemi

Manufacturer Product Number BS107ARL1

Description MOSFET N-CH 200V 250MA T092-3

Detailed Description N-Channel 200 V 250mA (Ta) 350mW (Ta) Through

Hole TO-92 (TO-226)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
BS107ARL1	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
200 V	250mA (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	6.40hm @ 250mA, 10V
Vgs(th) (Max) @ Id:	Vgs (Max):
3V @ 1mA	±20V
Input Capacitance (Ciss) (Max) @ Vds:	FET Feature:
60 pF @ 25 V	
Power Dissipation (Max):	Operating Temperature:
350mW (Ta)	-55°C ~ 150°C (TJ)
Mounting Type:	Supplier Device Package:
Through Hole	TO-92 (TO-226)
Package / Case:	Base Product Number:
TO-226-3, TO-92-3 Long Body (Formed Leads)	BS107

Environmental & Export classification

8541.21.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS.	

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Small Signal MOSFET

250 mA, 200 V, N-Channel TO-92

Features

- AEC-Q101 Qualified and PPAP Capable
- This is a Pb-Free Device*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	200	Vdc
Gate–Source Voltage – Continuous – Non–repetitive (t _p ≤ 50 μs)	V _{GS} V _{GSM}	±20 ±30	Vdc Vpk
Drain Current Continuous (Note 1) Pulsed (Note 2)	I _D	250 500	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	350	mW
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

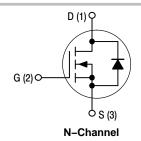
- The Power Dissipation of the package may result in a lower continuous drain current.
- 2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

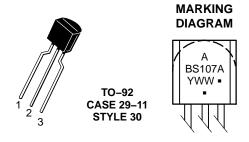


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250 mAMPS, 200 VOLTS $R_{DS(on)} = 6.4 \Omega$





A = Assembly Location

Y = Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping
BS107ARL1G	TO-92 (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•		•	•	•
Zero-Gate-Voltage Drain Current (V _{DS} = 130 Vdc, V _{GS} = 0)	I _{DSS}	_	_	30	nAdc
Drain–Source Breakdown Voltage (V _{GS} = 0, I _D = 100 μAdc)	V _{(BR)DSX}	200	-	-	Vdc
Gate Reverse Current (V _{GS} = 15 Vdc, V _{DS} = 0)	I _{GSS}	_	0.01	10	nAdc
ON CHARACTERISTICS (Note 3)					
Gate Threshold Voltage (I _D = 1.0 mAdc, V _{DS} = V _{GS})	V _{GS(Th)}	1.0	-	3.0	Vdc
Static Drain–Source On Resistance $BS107 (V_{GS} = 2.6 \text{ Vdc}, I_D = 20 \text{ mAdc})$ $(V_{GS} = 10 \text{ Vdc}, I_D = 200 \text{ mAdc})$ $BS107A (V_{GS} = 10 \text{ Vdc})$ $(I_D = 100 \text{ mAdc})$ $(I_D = 250 \text{ mAdc})$	r _{DS(on)}	- -	- - 4.5 4.8	28 14 6.0 6.4	Ω
SMALL-SIGNAL CHARACTERISTICS			4.0	0.4	1
Input Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz)	C _{iss}	-	60	-	pF
Reverse Transfer Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz)	C _{rss}	_	6.0	-	pF
Output Capacitance $(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0, f = 1.0 \text{ MHz})$	C _{oss}	-	30	-	pF
Forward Transconductance ($V_{DS} = 25 \text{ Vdc}$, $I_D = 250 \text{ mAdc}$)	9 _{fs}	200	400	-	mmhos
SWITCHING CHARACTERISTICS		_	_	_	_
Turn-On Time	t _{on}	-	6.0	15	ns
Turn-Off Time	t _{off}	_	12	15	ns

^{3.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

RESISTIVE SWITCHING

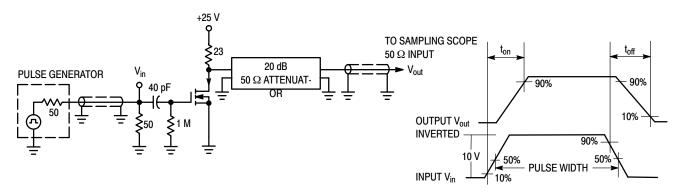


Figure 1. Switching Test Circuit

Figure 2. Switching Waveforms

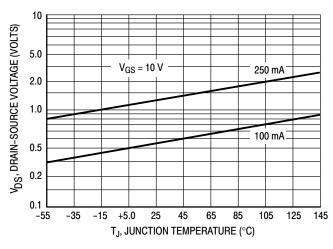


Figure 3. On Voltage versus Temperature

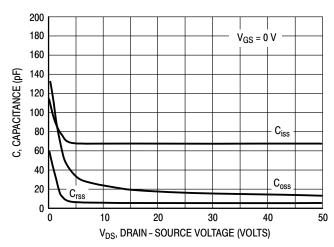


Figure 4. Capacitance Variation

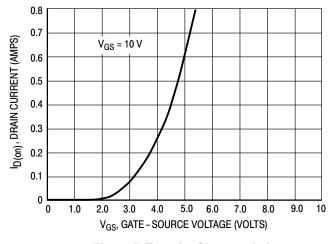


Figure 5. Transfer Characteristic

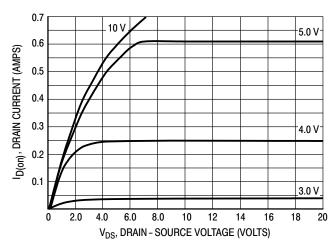


Figure 6. Output Characteristic

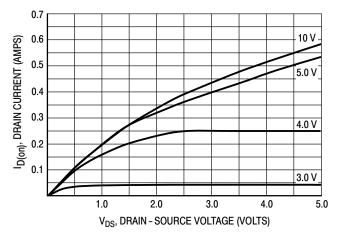
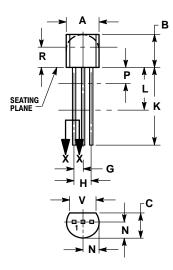


Figure 7. Saturation Characteristic

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AM

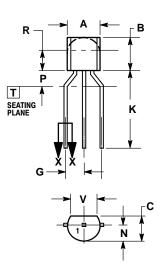


STRAIGHT LEAD **BULK PACK**



- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 CONTOUR OF PACKAGE BEYOND DIMENSION R
 IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
7	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
V	0.135		3 43	



BENT LEAD TAPE & REEL AMMO PACK



NOTES

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 CONTOUR OF PACKAGE BEYOND
 DIMENSION R IS UNCONTROLLED.

MILLIMETERS

LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	MIN	MAX	
Α	4.45	5.20	
В	4.32	5.33	
С	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
J	0.39	0.50	
K	12.70		
N	2.04	2.66	
Р	1.50	4.00	
R	2.93		
٧	3.43		

STYLE 30: PIN 1. DRAIN GATE 2. 3. SOURCE

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